

Process Change Notice

Parts Affected:

Small Signal MOSFETs.

Extent of Change:

The plastic molding compound used in manufacturing has been changed to an environmentally friendly, halogen free, "green" molding compound.

Reason for Change:

To comply with customer and industry requirements to provide environmentally friendly, halogen free devices.

Effect of Change:

To identify devices manufactured using the halogen free molding compound, a "G" suffix has been added to the part #'s of the devices listed below. This change does not affect the form, fit, or function of any device. The moisture sensitivity level for all devices remains unchanged at MSL 1.

Qualification:

Standard evaluation and qualifications completed resulting in no performance differences compared to current product.

Effective Date of Change:

September 1, 2009. Existing inventory will be shipped until it is depleted.

Part Numbers Affected:

The existing part numbers listed below will be replaced by the halogen free versions containing a "G" suffix.

| Existing Part #'s | Halogen Free Part #'s |
|--------------------------|------------------------------|
| CMPDM7002A | CMPDM7002AG |
| CMLDM7002A | CMLDM7002AG |
| CMLDM8002A | CMLDM8002AG |
| CMLDM7003 | CMLDM7003G |
| CMLDM7003T | CMLDM7003TG |
| CMPDM7120 | CMPDM7120G |
| CMLDM7120 | CMLDM7120G |
| CMLDM8120 | CMLDM8120G |

Sample Availability:

Please contact Salesperson or Manufacturer's Representative.